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Datasheet

LG Display

LP173WF5-SPB4

HD-10-162

G LG Display

Product Specification

SPECIFICATION
FOR
APPROVAL

(   )   **Preliminary Specification**

(◆)   **Final Specification**

Title	17.3" FHD TFT LCD

Customer	
MODEL	

SUPPLIER	LG Display Co., Ltd.
*MODEL	LP173WF5
Suffix	SPB4

*When you obtain standard approval,
please use the above model name without suffix

LGDDG-Distec-20.07.2021

APPROVED BY	**SIGNATURE**
/	
/	
/	

Please return 1 copy for your confirmation with your signature and comments.

APPROVED BY	**SIGNATURE**
J. Y. Lee / G. Manager	
REVIEWED BY	
I. Y. Jung / Manager [C]	
C. H. Lee / Manager [M]	
Y. D. Kim / Manager [P]	
PREPARED BY	
J. H. Chae / Engineer	

**Products Engineering Dept.
LG Display Co., Ltd**

Contents

Record of Revisions

Revision No	Revision Date	Page	Before	After	EDID version
0.0	Apr. 25. 2019	All	First Draft (Preliminary Specification)	-	0.0
1.0	Jun. 10. 2019	21	-	Update Mechanical Characteristics	1.0
		25	-	Update Packing	
		50	-	Update APPENDIX C.	

Product Specification

1. General Description

The LP173WF5 is a Color Active Matrix Liquid Crystal Display with an integral LED backlight system. The matrix employs a-Si Thin Film Transistor as the active element. It is a transmissive type display operating in the normally Black mode. This TFT-LCD has 17.3 inches diagonally measured active display area with FHD resolution (1920 horizontal by 1080 vertical pixel array). Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 6-bit+FRC gray scale signal for each dot, thus, presenting a palette of more than 16,194,277 colors. The LP173WF5 has been designed to apply the interface method that enables low power, high speed, low EMI. The LP173WF5 is intended to support applications where thin thickness, low power are critical factors and graphic displays are important. In combination with the vertical arrangement of the sub-pixels, the LP173WF5 characteristics provide an excellent flat display for office automation products such as Notebook PC.
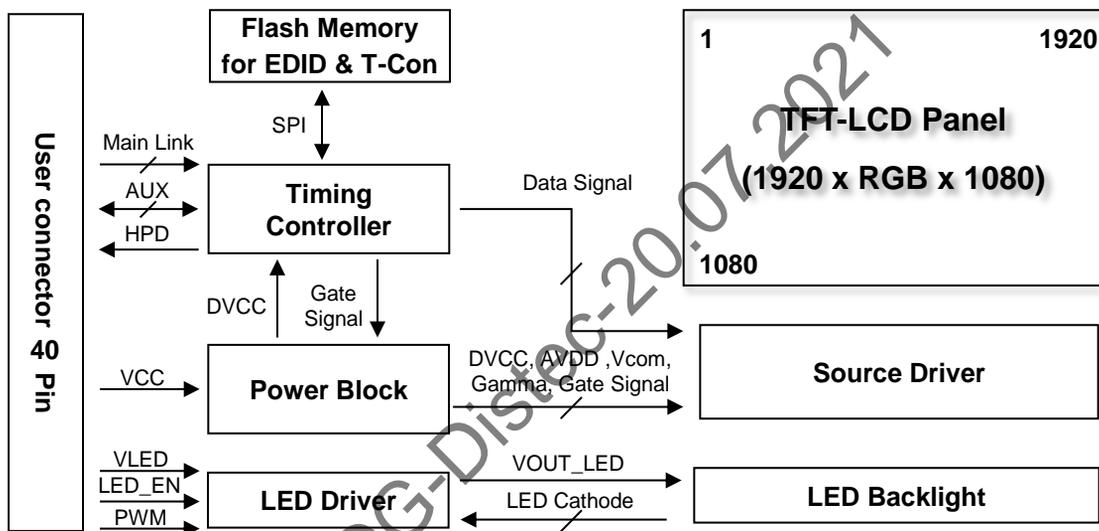
General Features

Active Screen Size	17.3 inches diagonal
Outline Dimension	389.89(H, Typ.) × 238.31(V, Typ.) × 3.5(D, Max.) [mm] (with PCB Board)
Pixel Pitch	0.1989 mm X 0.1989 mm
Pixel Format	1920 horiz. by 1080 vert. Pixels RGB strip arrangement
Color Depth	6-bit FRC, 16,194,277 colors
Luminance, White	300 cd/m^2(Typ.)
Power Consumption	Total 5.45W (Typ.) Logic : 0.8W (Typ. @ Mosaic), B/L : 4.65W (Typ.)
Weight	500g (Max.)
Display Operating Mode	Normally black
Surface Treatment	Anti-Glare treatment (3H) of the front Polarizer
RoHS Compliance	Yes
BFR / PVC / As Free	Yes for all
eDP version(Tcon)	eDP1.2
DPCD version	Ver1.2

PSR	MBO	sDRRS	SSC	NVSR	G-sync
Not support	Not support	Support	Support	Not Support	Not support

Note : Based on system condition(PSR support/PSR none support), Flash Memory data should be changed.

Product Specification

2. Absolute Maximum Ratings

The following are maximum values which, if exceeded, may cause faulty operation or damage to the unit.

Table 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Values		Units	Notes
		Min	Max		
Power Input Voltage	VCC	-0.3	4.0	V_{DC}	at 25 ± 2°C
Operating Temperature	TOP	0	50	°C	1
Storage Temperature	TST	-20	60	°C	1,2
Operating Ambient Humidity	HOP	10	90	%RH	1
Storage Humidity	HST	10	90	%RH	1,2

Note : 1. Temperature and relative humidity range are shown in the figure below.
　　　　Wet bulb temperature should be 39°C Max, and no condensation of water.
Note : 2. Storage Condition is guaranteed under packing condition.

Wet Bulb Temperature [℃]

Humidity[(%)RH]

Storage

Operation

Dry Bulb Temperature [℃]
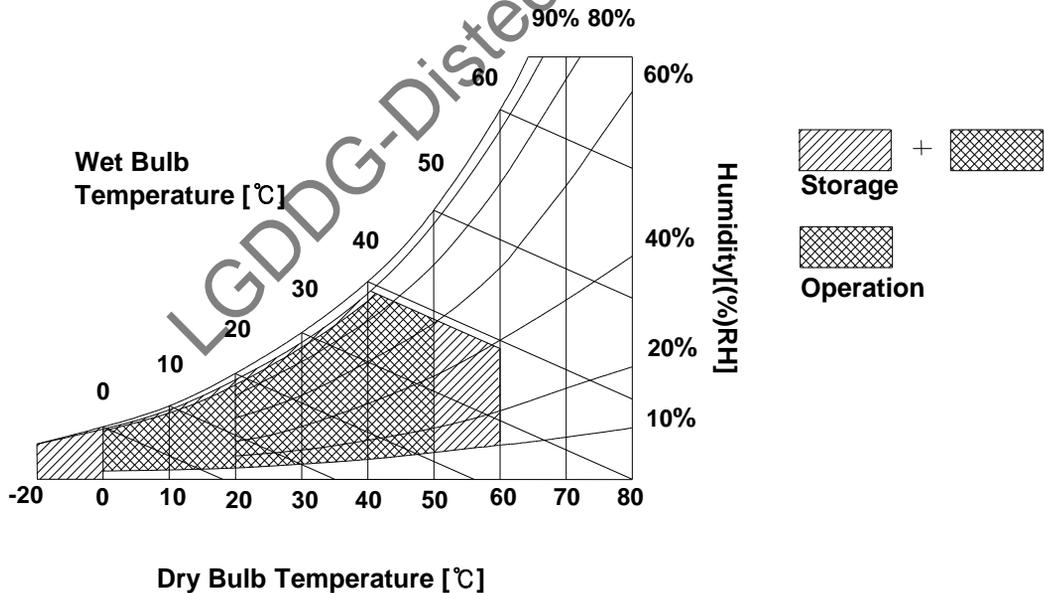
3. Electrical Specifications

3-1. LCD Electrical Characteristics

Table 2. LCD ELECTRICAL CHARACTERISTICS

Parameter		Symbol	Min	Typ	Max	Unit	Notes
Power Supply Input Voltage		V_{CC}	3.0	3.3	3.6	V	1
Permissive Power Supply Input Ripple		V_{CCrp}	-	-	100	mV_{p-p}	
Power Supply Input Current	Mosaic	I_{CC}	-	245	305	mA	2
	Red(Solid)	I_{CC}	-	380	440	mA	
Power Consumption		P_{CC}	-	0.8	1.0	W	
Power Supply Inrush Current		I_{CC_P}	-	-	1.5	A	3
Differential Impedance		Z_{eDP}	90	100	110	Ω	

Note)
1. The measuring position is the connector of LCM and the test conditions are under 25℃, fv = 60Hz
2. The specified I_{CC} current and power consumption are under the V_{CC} = 3.3V , 25℃, fv = 60Hz condition and Mosaic pattern.

<Mosaic>   <Red>
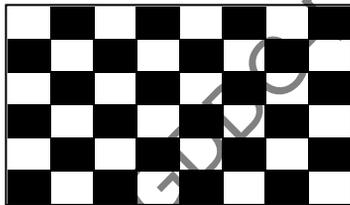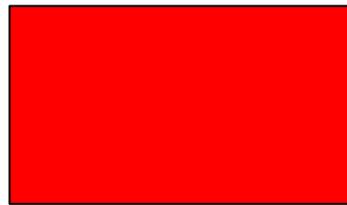
3. The V_{CC} rising time is same as the minimum of T1 at Power on sequence.

Rising time V_{CC}

3.3V
90%
0V   10%
0.5ms

Product Specification
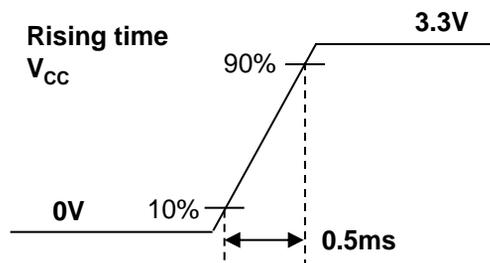
3-2. LED Backlight Electrical Characteristics

Table 3. LED B/L ELECTRICAL CHARACTERISTICS

| Parameter		Symbol	Values			Unit	Notes
			Min	Typ	Max		
LED Power Input Voltage		V_LED	6.0	12.0	21.0	V	1
LED Power Input Current		I_LED	-	390	400	mA	2
LED Power Consumption		P_LED	-	4.65	4.8	W	
LED Power Inrush Current		I_LED_P	-	-	1.5	A	3
PWM Duty Ratio			5	-	100	%	4
PWM Resolution				10		Bit	5
PWM Jitter			0	-	0.05	%	6
PWM Frequency		F_PWM	200	-	2000	Hz	7
PWM	High Level Voltage	V_PWM_H	2.5	-	3.6	V	
	Low Level Voltage	V_PWM_L	0	-	0.3	V	
	Rising Time	Tr_PWM	-	-	500	ns	
	Falling Time	Tf_PWM	-	-	500	ns	
LED_EN	High Voltage	V_LED_EN_H	2.5	-	3.6	V	
	Low Voltage	V_LED_EN_L	0	-	0.3	V	
Life Time			15,000	-	-	Hrs	8

Note)

1. The measuring position is the connector of LCM and the test conditions are under 25℃.

2. The current and power consumption with LED Driver are under the V_{LED} = 12.0V , 25℃, PWM Duty 100% and White pattern with the normal frame frequency operated(60Hz).

3. The V_{LED} rising time is same as the minimum of T13 at Power on sequence.

Rising time
V_LED
12.0V
90%
0V   10%
0.5ms
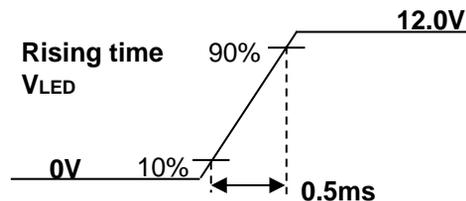
4. The operation of LED Driver below minimum dimming ratio may cause flickering or reliability issue.

5. 10bit resolution means it's possible to change PWM duty by 0.1% step. (8bit operated by 0.4% step)

6. The PWM frequency was selected to avoid for wave noise. Need to check by system side

7. This Spec. is not effective at 100% dimming ratio as an exception because it has DC level equivalent to 0Hz. In spite of acceptable range as defined, the PWM Frequency should be fixed and stable for more consistent brightness control at any specific level desired.

8. The life time is determined as the time at which brightness of LCD is 50% compare to that of minimum value specified in table 7. under general user condition.

3-3. Interface Connections

Table 4. MODULE CONNECTOR PIN CONFIGURATION (CN1)

Pin	Symbol	Description	Notes
1	NC	No Connection	
2	GND	High Speed Ground	
3	Lane1_N	Complement Signal Link Lane 1	
4	Lane1_P	True Signal Link Lane 1	
5	GND	High Speed Ground	
6	Lane0_N	Complement Signal Link Lane 0	
7	Lane0_P	True Signal Link Lane 0	
8	GND	High Speed Ground	
9	AUX_CH_P	True Signal Auxiliary Channel	[Connector]
10	AUX_CH_N	Complement Signal Auxiliary Channel	LSC, GT05Q-30S-H10-MN
11	GND	High Speed Ground	(30pin, 0.5pitch) or equivalent
12	VCC	LCD logic and driver power	
13	VCC	LCD logic and driver power	
14	NC	No Connection	[Connector pin arrangement]
15	GND	LCD logic and driver ground	
16	GND	LCD logic and driver ground	
17	HPD	HPD signal pin	
18	BL_GND	LED Backlight ground	
19	BL_GND	LED Backlight ground	
20	BL_GND	LED Backlight ground	
21	BL_GND	LED Backlight ground	[LGD P-Vcom using information]
22	BL ENABLE	LED Backlight control on/off control	1. Pin for P-Vcom : #24, #25
23	BL PWM	System PWM signal input for dimming	2. P-Vcom Address : 0101000x
24	NC Reserved	Reserved for LCD manufacture's use	
25	NC Reserved	Reserved for LCD manufacture's use	
26	VLED	LED Backlight power (12V Typical)	
27	VLED	LED Backlight power (12V Typical)	
28	VLED	LED Backlight power (12V Typical)	
29	VLED	LED Backlight power (12V Typical)	
30	NC	No Connection	
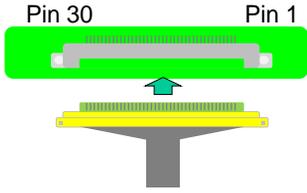
3-3-1. Input/output signal circuit

Figure1. HPD Output circuit is as below

HPD

1.2k ohm

100k ohm

Figure2. BL PWM input circuit is as below

BL PWM

1.2k ohm

Figure3. BL Enable input circuit is as below

BL ENABLE

1.2k ohm

0.1 uF

Figure4. BIST input circuit is as below

BIST

1.2K ohm

3-4. eDP Signal Timing Specifications

3-4-1. Definition of Differential Voltage

Common Mode Voltage

$V_{CM} = (V_{D+} + V_{D-}) / 2$

$V_{DIFF} = V_{D+} - V_{D-}$

$V_{DIFFp-p} = (2^* \max | V_{D+} - V_{D-} |)$

V_{D+}

V_{CM}

V_{D-}

V_{DIFF}

0 V

V_{DIFF}

V_{CM}

$V_{DIFFp-p}$

[Definition of Differential Voltage]
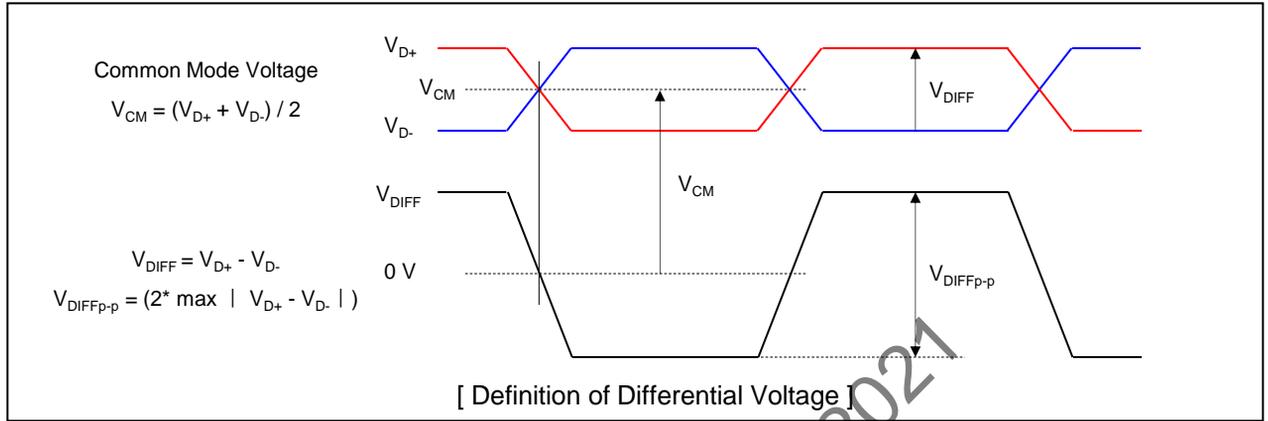
3-4-2. Main Link EYE Diagram

Volts
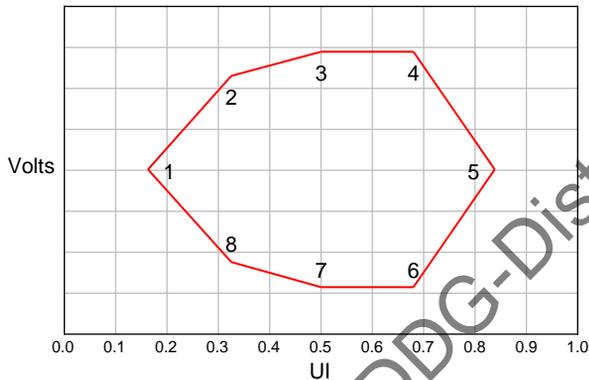
[EYE Mask at Source Connector Pins]

Volts

[EYE Mask at Sink Connector Pins]

Point	Reduced Bit Rate		High Bit Rate	
	Time(UI)	Voltage(V)	Time(UI)	Voltage(V)
1	0.127	0.000	0.210	0.000
2	0.291	0.160	0.355	0.140
3	0.500	0.200	0.500	0.175
4	0.709	0.200	0.645	0.175
5	0.873	0.000	0.790	0.000
6	0.709	-0.200	0.645	-0.175
7	0.500	-0.200	0.500	-0.175
8	0.291	-0.160	0.355	-0.140

[EYE Mask Vertices at Source Connector Pins]

Point	Reduced Bit Rate		High Bit Rate	
	Time(UI)	Voltage(V)	Time(UI)	Voltage(V)
1	0.375	0.000	0.246	0.000
2	0.500	0.023	0.500	0.075
3	0.625	0.000	0.755	0.000
4	0.500	-0.023	0.500	-0.075

[EYE Mask Vertices at Sink Connector Pins]

Point	Reduced Bit Rate		High Bit Rate	
	Time(UI)	Voltage(V)	Time(UI)	Voltage(V)
1	0.270	0.000	0.246	0.000
2	0.500	0.068	0.500	0.075
3	0.731	0.000	0.755	0.000
4	0.500	-0.068	0.500	-0.075

[EYE Mask Vertices at embedded DP Sink Connector Pins]

3-4-3. eDP Main Link Signal

[Main Link Differential Pair]
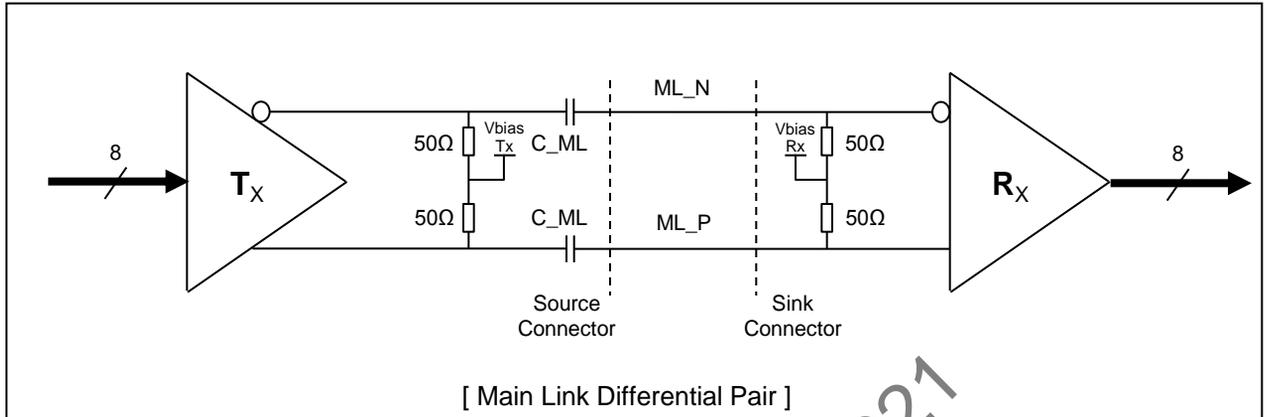
Parameter	Symbol	Min	Typ	Max	Unit	Notes
Unit Interval for high bit rate (2.7Gbps / lane)	UI_HBR	-	370	-	ps	
Unit Interval for reduced bit rate (1.62Gbps / lane)	UI_RBR	-	617	-	ps	
Link Clock Down Spreading	Amplitude	0	-	0.5	%	
	Frequency	30		33	kHz	
Differential peak-to-peak voltage at Source side connector	$V_{TX-DIFFp-p}$	350	-	-	mV	For HBR(2.7Gbps)
		400	-	-		For RBR(1.62Gbps)
EYE width at Source side connector	$T_{TX-EYE-CONN}$	0.58	-	-	UI	For HBR(2.7Gbps)
		0.75	-	-	UI	For RBR(1.62Gbps)
Differential peak-to-peak voltage at Sink side connector	$V_{RX-DIFFp-p}$	150	-	-	mV	For HBR(2.7Gbps)
		136	-	-		For RBR(1.62Gbps)
EYE width at Sink side connector	$T_{RX-EYE-CONN}$	0.51	-	-	UI	For HBR(2.7Gbps)
		0.46	-	-	UI	For RBR(1.62Gbps)
Rx DC common mode voltage	$V_{RX\ CM}$	0	-	1.0	V	
AC Coupling Capacitor	$C_{SOURCE-ML}$	75		200	nF	Source side

Note)
1. Termination resistor is typically integrated into the transmitter and receiver implementations.
2. AC Coupling Capacitor is not placed at the sink side.
3. In cabled embedded system, it is recommended the system designer ensure that EYE width and voltage are met at the sink side connector pins.

3-4-4. eDP AUX Channel Signal

[Recommended eDP AUX Channel Differential Pair]
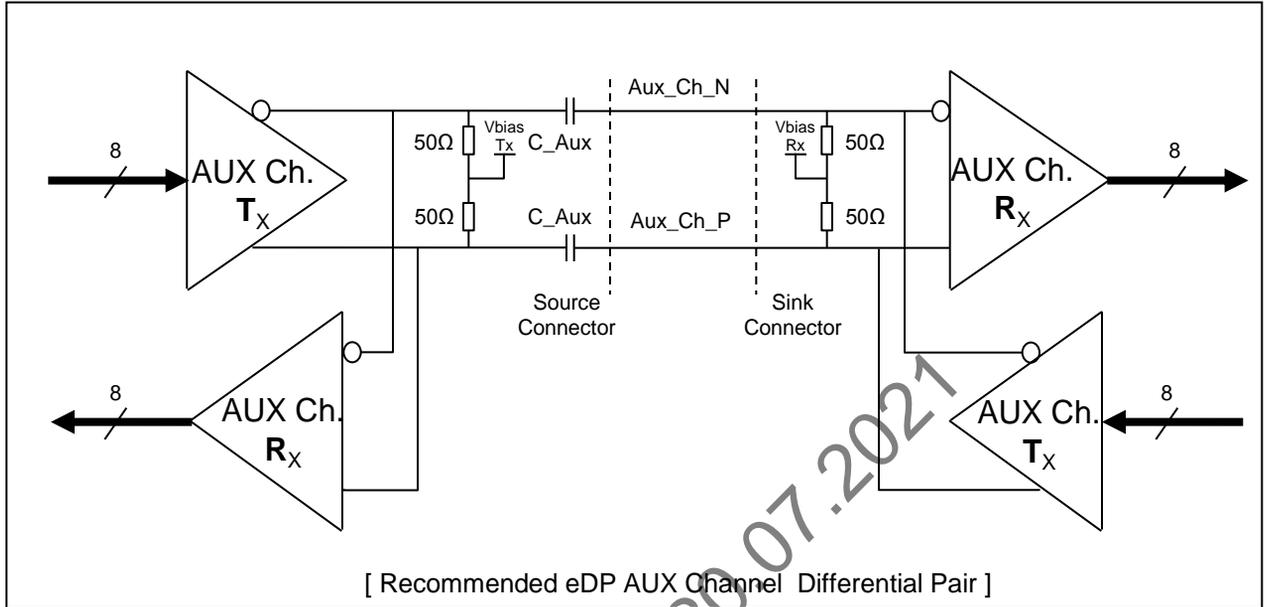
Parameter	Symbol	Min	Typ	Max	Unit	Notes
AUX Unit Interval	UI	0.4	-	0.6	us	
AUX Jitter at Tx IC Package Pins	T_{jitter}	-	-	0.04	UI	Equal to 24ns
AUX Jitter at Rx IC Package Pins		-	-	0.05	UI	Equal to 30ns
AUX Peak-to-peak voltage at Connector Pins of Receiving	$V_{AUX-DIFFp-p}$	0.39	-	1.38	V	
AUX Peak-to-peak voltage at Connector Pins of Transmitting		0.36	-	1.36	V	
AUX EYE width at Connector Pins of Tx and Rx		0.98	-	-	UI	
AUX DC common mode voltage	V_{AUX-CM}	0	-	1.0	V	
AUX AC Coupling Capacitor	$C_{SOURCE-AUX}$	75		200	nF	Source side

Note)
1. Termination resistor is typically integrated into the transmitter and receiver implementations.
2. AC Coupling Capacitor is not placed at the sink side.
3. $V_{AUX-DIFFp-p} = 2* \mid V_{AUXP}-V_{AUXN} \mid$

3-4-5. eDP HPD Signal

[HPD Events]
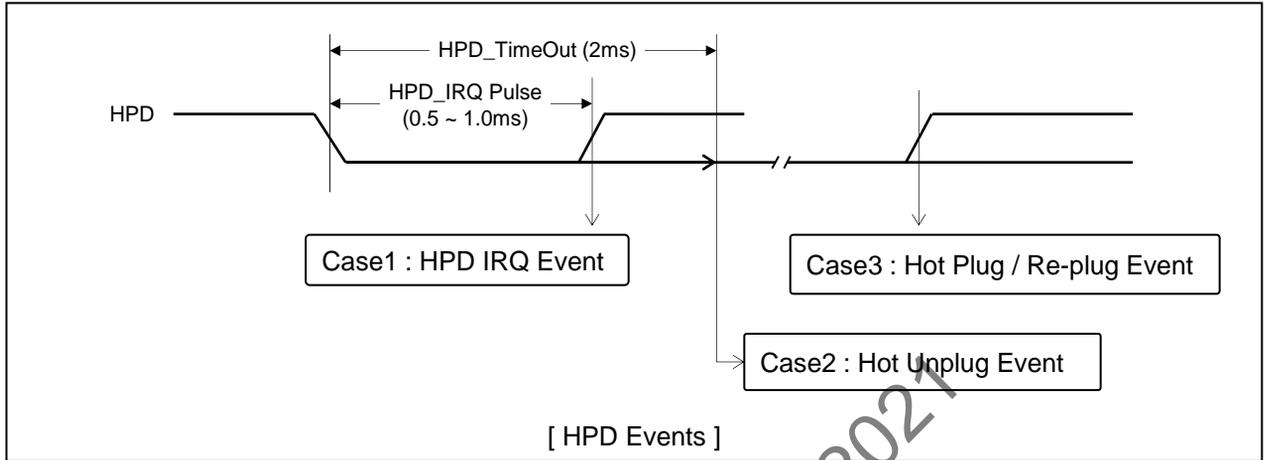
Parameter	Symbol	Min	Typ	Max	Unit	Notes
HPD Voltage	HPD	2.25	-	3.6	V	Sink side Driving
Hot Plug Detection Threshold		2.0	-	-	V	Source side Detecting
Hot Unplug Detection Threshold		-	-	0.8	V	
HPD_IRQ Pulse Width	HPD_IRQ	0.5	-	1.0	ms	
HPD_TimeOut		2.0	-	-	ms	HPD Unplug Event

Note)
1. HPD IRQ : Sink device wants to notify the Source device that Sink's status has changed so it toggles HPD line, forcing the Source device to read its Link / Sink Receiver DPCD field via the AUX-CH
2. HPD Unplug : The Sink device is no longer attached to the Source device and the Source device may then disable its Main Link as a power saving mode
3. Plug / Re-plug : The Sink device is now attached to the Source device, forcing the Source device to read its Receiver capabilities and Link / Sink status Receiver DPCD fields via the AUX-CH

3-5. Signal Timing Specifications

This is the signal timing required at the input of the User connector. All of the interface signal timing should be satisfied with the following specifications and specifications of eDP Tx/Rx for its proper operation.

Table 4. TIMING TABLE

ITEM	Symbol		Min	Typ	Max	Unit	Note
DCLK	Frequency	f_{CLK}	-	138.7	-	MHz	
Hsync	Period	t_{HP}	2072	2080	2088	t_{CLK}	
	Width	t_{WH}	32	32	32		
	Width-Active	t_{WHA}		1920			
Vsync	Period	t_{VP}	1108	1111	1114	t_{HP}	
	Width	t_{WV}	5	5	5		
	Width-Active	t_{WVA}		1080			
Data Enable	Horizontal back porch	t_{HBP}	72	80	88	t_{CLK}	
	Horizontal front porch	t_{HFP}	48	48	48		
	Vertical back porch	t_{VBP}	20	23	24	t_{HP}	
	Vertical front porch	t_{VFP}	3	3	5		

Notice. all reliabilities are specified for timing specification based on refresh rate of 60Hz. However, LP173WF5 has a good actual performance even at lower refresh rate (e.g. 40Hz or 50Hz) for power saving Mode, whereas LP173WF5 is secured only for function under lower refresh rate. 60Hz at Normal mode, 50Hz, 40Hz at Power save mode. Don't care Flicker level (Power save mode).

3-6. Signal Timing Waveforms

Data Enable, Hsync, Vsync — High: 0.7VCC, Low: 0.3VCC — Condition : VCC =3.3V
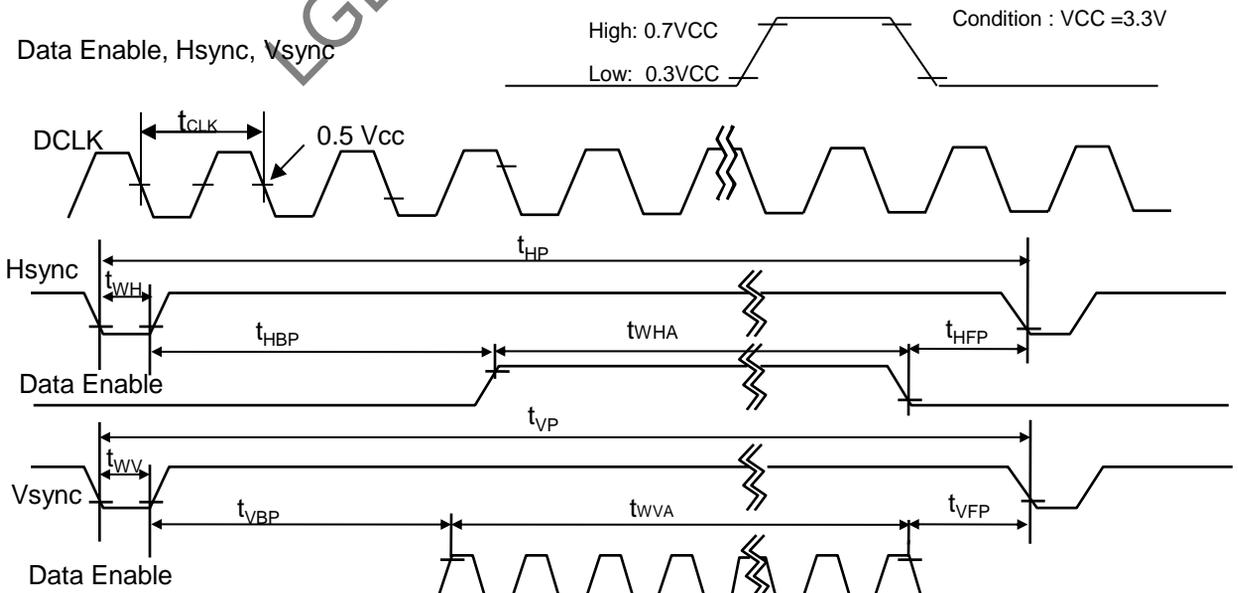
3-7. Color Input Data Reference

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color ; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

Table 5. COLOR DATA REFERENCE

Color		Input Color Data																							
		RED								GREEN								BLUE							
		MSB							LSB	MSB							LSB	MSB							LSB
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RED	RED (0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	…				…								…								…				
	RED (254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
GREEN	GREEN (0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	...				…								…								…				
	GREEN (254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	GREEN (255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
BLUE	BLUE (0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	…				…								…								…				
	BLUE (254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	BLUE (255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

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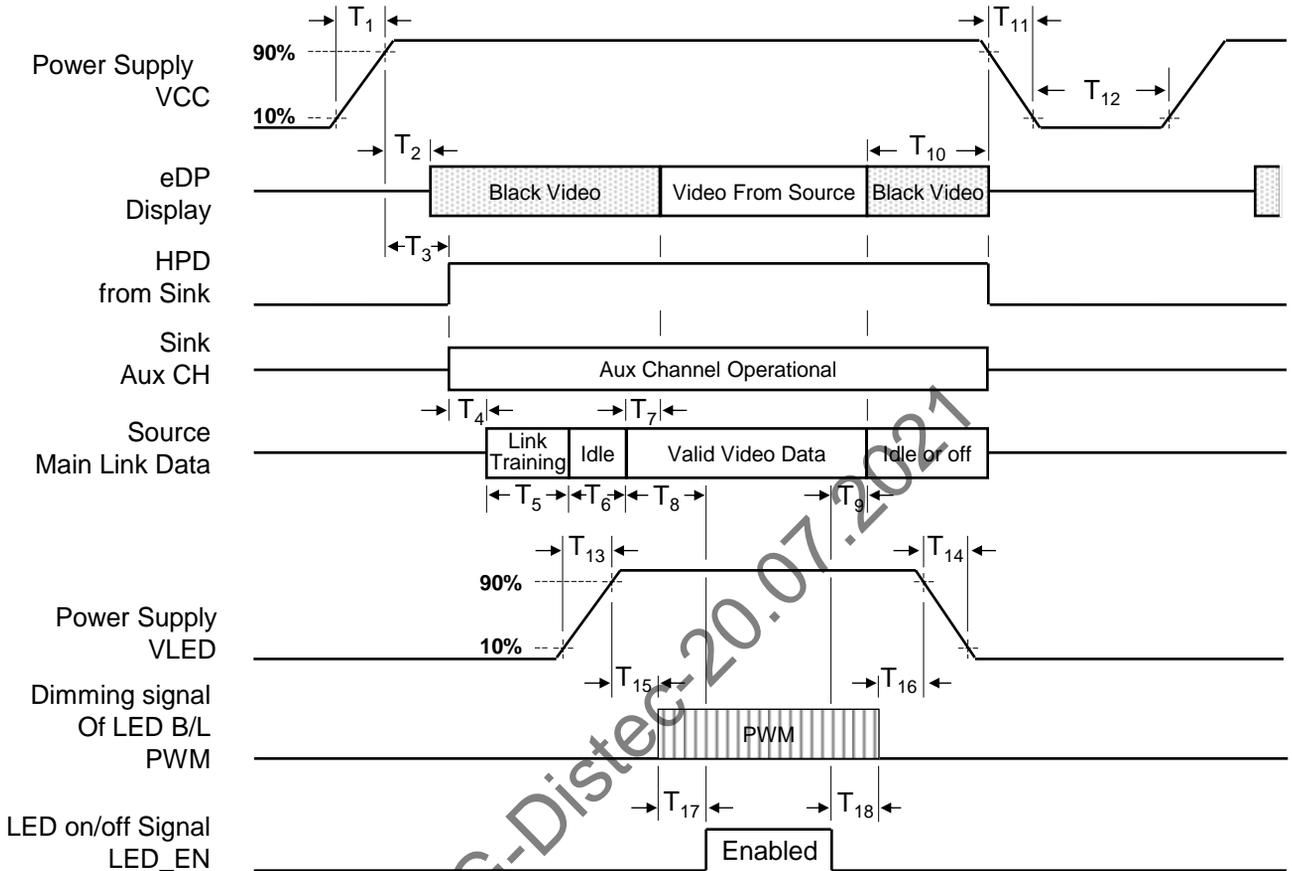
3-8. Power Sequence

Table 6. POWER SEQUENCE TABLE

Symbol	Required By	Limits Min	Limits Max	Units	Notes	Symbol	Required By	Limits Min	Limits Max	Units	Notes
T_1	Source	0.5	10	ms	-	T_{10}	Source	0	500	ms	-
T_2	Sink	0	200	ms	-	T_{11}	Source	-	10	ms	-
T_3	Sink	0	200	ms	-	T_{12}	Source	500	-	ms	
T_4	Source	-	-	ms	-	T_{13}	Source	0.5	10	ms	-
T_5	Source	-	-	ms	-	T_{14}	Source	0.5	10	ms	-
T_6	Source	-	-	ms	-	T_{15}	Source	10	-	ms	-
T_7	Sink	0	50	ms	-	T_{16}	Source	10	-	ms	-
T_8	Source	-	-	ms	5	T_{17}	Source	0	-	ms	-
T_9	Source	-	-	ms	6	T_{18}	Source	0	-	ms	-

Note) 1. Do not insert the mating cable when system turn on.
2. Valid Data have to meet "3-3. eDP Signal Timing Specifications"
3. Video Signal, LED_EN and PWM need to be on pull-down condition on invalid status.
4. LGD recommend the rising sequence of VLED after the Vcc and valid status of Video Signal turn on.
5. Driving signal of B/L must be "On" after normal video signal (Normal operating data from source) input.
6. B/L driving must be "Off" before normal signal (Normal operating data from source) finish.

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 20 minutes in a dark environment at 25°C. The values specified are at an approximate distance 50cm from the LCD surface at a viewing angle of Φ and Θ equal to 0°.
FIG. 1 presents additional information concerning the measurement equipment and method.

### FIG. 1 Optical Characteristic Measurement Equipment and Method

Optical Stage(x,y)   **LCD Module**   **Equipment**

1°

500mm±50mm
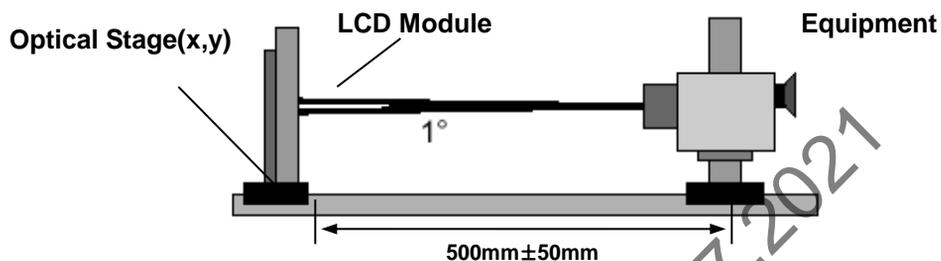
Table 7. OPTICAL CHARACTERISTICS

Ta=25°C, VCC=3.3V, fv=60Hz

Parameter		Symbol	Values			Units	Notes
			Min	Typ	Max		
Contrast Ratio		CR	600	800	-		1
Surface Luminance, white		L$_{WH}$	255	300	-	cd/m^2	2
Luminance Variation		δ $_{WHITE (5P)}$	-	1.2	1.4	-	3
		δ $_{WHITE(13P)}$	-	1.4	1.6		
Response Time		Tr + Tf	-	16	25	ms	4
Color Coordinates	RED	Rx	Typical - 0.03	0.640	Typical + 0.03		5
		Ry		0.330			
	GREEN	Gx		0.305			
		Gy		0.605			
	BLUE	Bx		0.150			
		By		0.055			
	WHITE	Wx		0.313			
		Wy		0.329			
Viewing Angle	x axis, right(Φ=0°)	Θr	80	-	-	Degree	6
	x axis, left (Φ=180°)	Θl	80	-	-		
	y axis, up (Φ=90°)	Θu	80	-	-		
	y axis, down (Φ=270°)	Θd	80	-	-		
Gray Scale							7

Product Specification

Note)
1. It should be measured in the center of screen(1 Point). Contrast Ratio(CR) is defined mathematically as

$$\text{Contrast Ratio(1 Point)} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

2. Surface luminance is the average of 5 point across the LCD surface 50cm from the surface with all pixels displaying white. For more information see FIG 2.

$$L_{WH} = \text{Average}(1,2, \ldots 5 \text{ Point})$$

3. The variation in surface luminance , The panel total variation (δ WHITE) is determined by measuring N at each test position 1 through 13 and then defined as following numerical formula. For more information see FIG 2.

$$\delta \text{ WHITE (5P)} = \frac{\text{Maximum }(1,2, \ldots 5 \text{ Point})}{\text{Minimum }(1,2, \ldots 5 \text{ Point})} \qquad \delta \text{ WHITE (13P)} = \frac{\text{Maximum }(1,2, \ldots 13 \text{ Point})}{\text{Minimum }(1,2, \ldots 13 \text{ Point})}$$

4. Response time is the time required for the display to transition from black to white (rise time, Tr) and from white to black (falling time, Tf). For additional information see FIG 3.

5. It should be measured in the center of screen (1Point).

6. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 4.

7. Gray scale specification

Gray Level	Luminance [%] (Typ)
L0	0.1
L7	0.5
L15	2.8
L23	8.4
L31	18.5
L39	33.2
L47	51.4
L55	70.9
L63	100

FIG. 2 Luminance

<Measuring point for Average Luminance & measuring point for Luminance variation>

H,V : ACTIVE AREA
A : H/4 mm
B : V/4 mm
POINTS: 13 POINTS
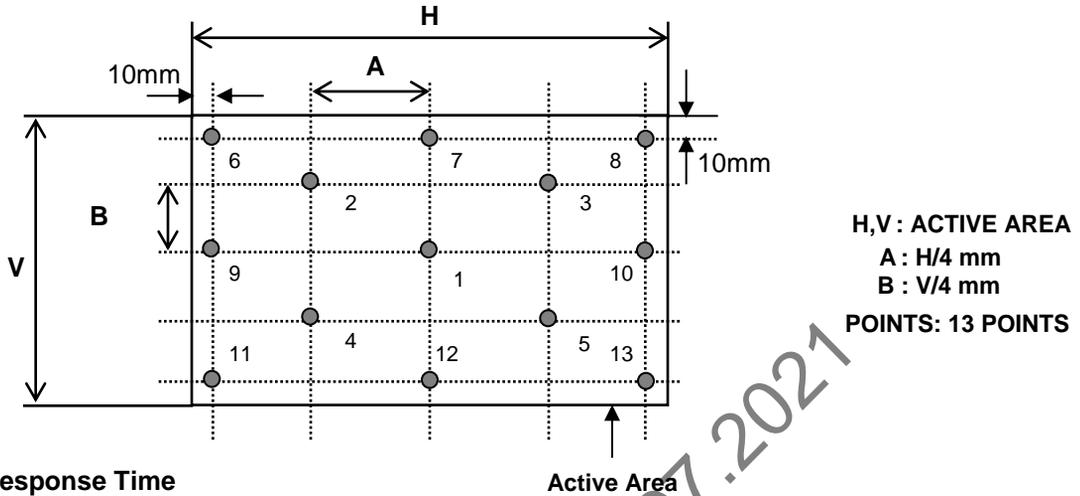
FIG. 3 Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".
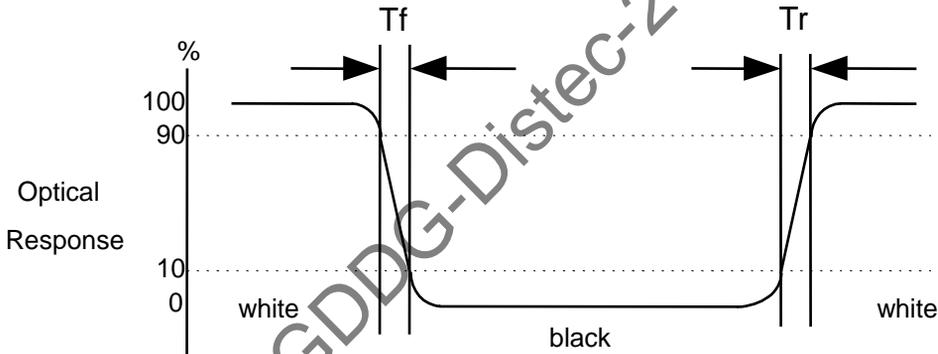
FIG. 4 Viewing angle

<Dimension of viewing angle range>
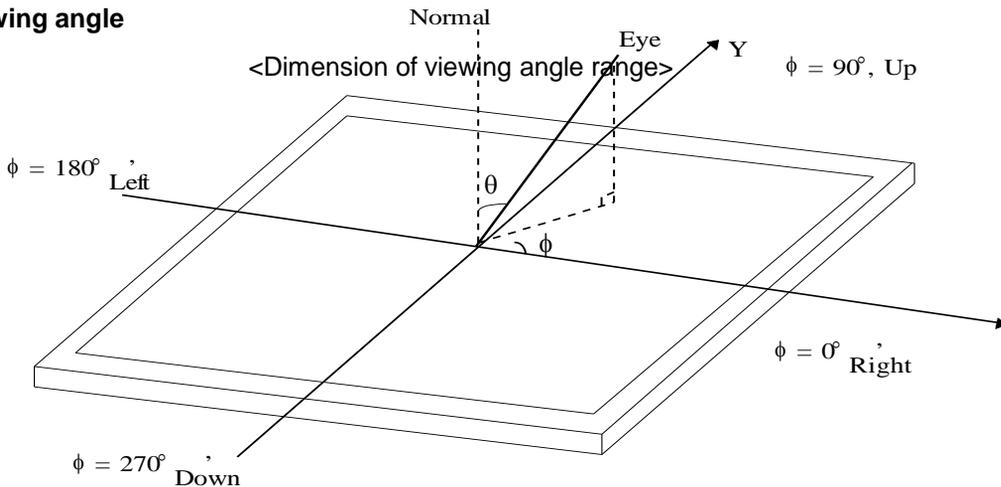
$\phi = 90°$, Up
$\phi = 180°$ Left
$\phi = 0°$ Right
$\phi = 270°$ Down

5. Mechanical Characteristics

The contents provide general mechanical characteristics for the model LP173WF5. In addition the figures in the next page are detailed mechanical drawing of the LCD.

Outline Dimension	Horizontal	389.89 ± 0.3 mm
	Vertical	238.31 ± 0.5 mm (with PCB Board)
	Thickness	3.5 mm (Max.)
Upper Polarizer Dimension	Horizontal	385.09 ± 0.3 mm
	Vertical	218.21 ±0.3 mm
Active Display Area	Horizontal	381.89 mm
	Vertical	214.81 mm
Weight	500g (Max.)	
Surface Treatment	Hard Coating(3H), Anti-Glare treatment of the front polarizer	

Product Specification

<FRONT VIEW>

Notes (Measurement method refer to the Appendix D)
1) Unit[mm], General tolerance : ± 0.5mm
2) All components except cover shield of LCM is under upper POL.
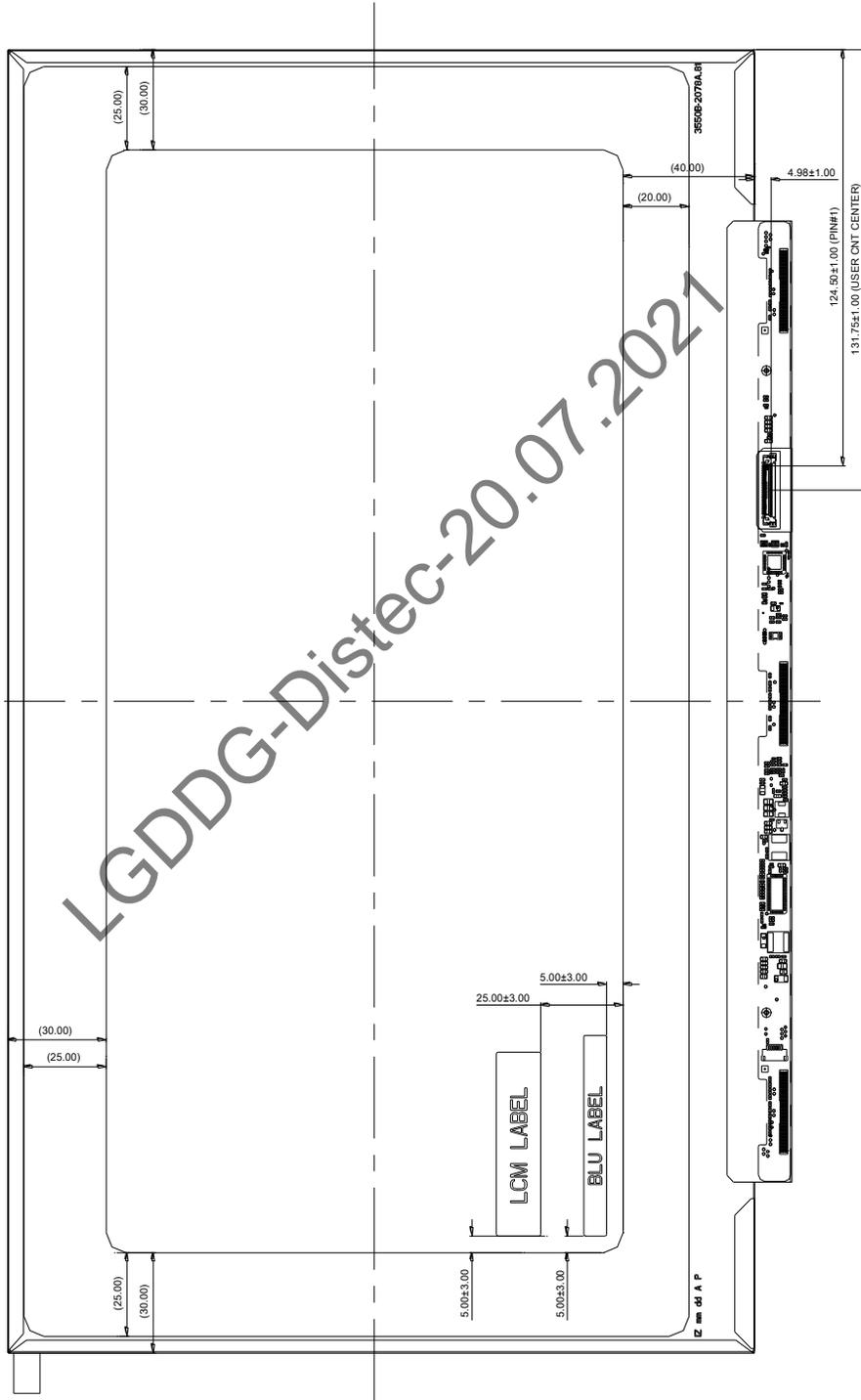
6. Reliability

Environment test condition

No.	Test Item	Conditions
1	High temperature storage test	Ta= 60°C, 240h
2	Low temperature storage test	Ta= -20°C, 240h
3	High temperature operation test	Ta= 50°C, 50%RH, 240h
4	Low temperature operation test	Ta= 0°C, 240h
5	Vibration test (non-operating)	Random, 1.0Grms, 10 ~ 300Hz(PSD 0.0035) 3 axis, 30min/axis
6	Shock test (non-operating)	- No functional or cosmetic defects following a shock to all 6 sides delivering at least 180 G in a half sine pulse no longer than 2 ms to the display module - No functional defects following a shock delivering at least 200 g in a half sine pulse no longer than 2 ms to each of 6 sides. Each of the 6 sides will be shock tested with one each display, for a total of 6 displays
7	Altitude operating storage / shipment	0 ~ 10,000 feet (3,048m) 24Hr 0 ~ 40,000 feet (12,192m) 24Hr
8	ESD	+ 8kV for contact discharge + 15kV for air discharge

[Result Evaluation Criteria]

1. Comparing the initial functional FOS status, there should be no major change which might affect the practical display function when the display reliability test is conducted.

2. After conduct reliability tests, LGD guarantees only functional FOS quality.

3. In the Reliability Test, Confirm performance after leaving in room temp.

4. In the standard condition, there shall be no practical problems that may affect the display function 24 hours later after reliability test. After the reliability test, we can guarantee the product only when the corrosion is causing its malfunction. The corrosion causing no functional defect can not be guaranteed.

7. International Standards

7-1. Safety

a) UL 60950-1, Underwriters Laboratories Inc.
Information Technology Equipment - Safety - Part 1 : General Requirements.
b) CAN/CSA-C22.2 No. 60950-1-07, Canadian Standards Association.
Information Technology Equipment - Safety - Part 1 : General Requirements.
c) EN 60950-1, European Committee for Electro technical Standardization (CENELEC).
Information Technology Equipment - Safety - Part 1 : General Requirements.
d) IEC 60950-1, The International Electro technical Commission (IEC).
Information Technology Equipment - Safety - Part 1 : General Requirements

7-2. Environment

a) RoHS, Directive 2011/65/EU of the European Parliament and of the council of 8 June 2011

8. Packing

8-1. Designation of Lot Mark

a) Lot Mark

| A | B | C | D | E | F | G | H | I | J | K | L | M |

A,B,C : SIZE(INCH) D : YEAR
E : MONTH F ~ M : SERIAL NO.
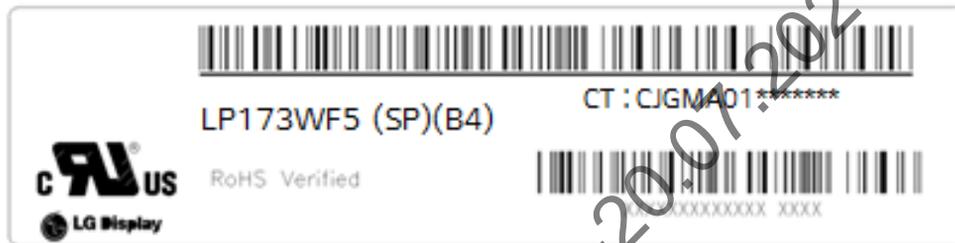
Note

1. YEAR

Year	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020
Mark	A	B	C	D	E	F	G	H	J	K

2. MONTH

| Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	3	4	5	6	7	8	9	A	B	C

b) Location of Lot Mark

Serial No. is printed on the label. The label is attached to the backside of the LCD module.
This is subject to change without prior notice.

8-2. Packing Form

a) Package quantity in one box : 24 pcs

b) Box Size : 478 x 365 x 328

8-3. Packing Assembly

1 LCM / 1 Bag

2 LCM / 1 Slot

24LCM/Box = 120 Slot

No silica gel in the box

NO.	DESCRIPTION	MATERIAL
1	LCD Module	
2	BAG	AL
3	TAPE	MASKING 20MMX50M
4	PACKING, TOP	EPS
5	PACKING, BOTTOM	EPS
6	BOX	SWR4
7	TAPE	OPP 70MMX300M
8	LABEL	ART 100X70
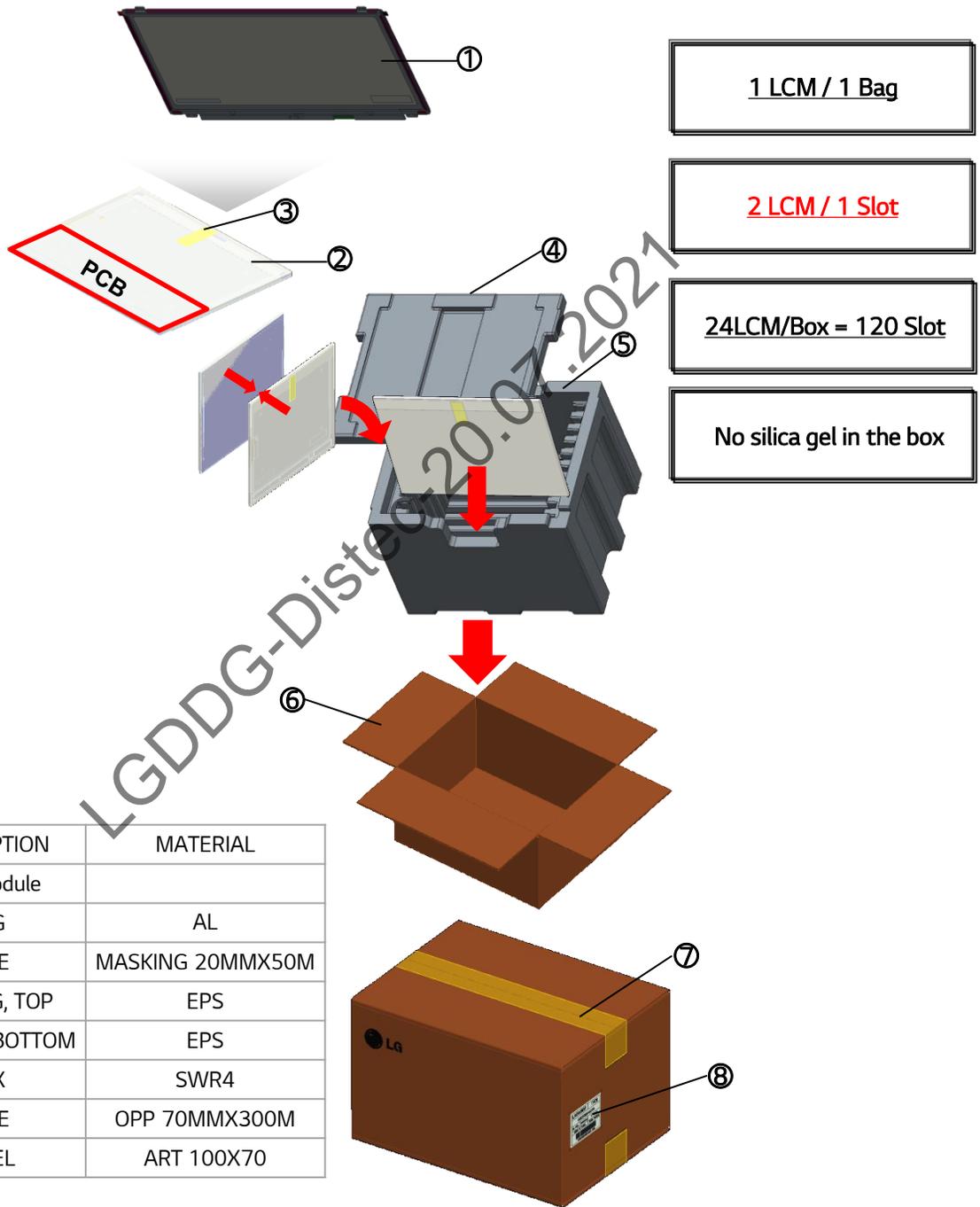
8-4. Pallet Assembly

1. Pallet Ready
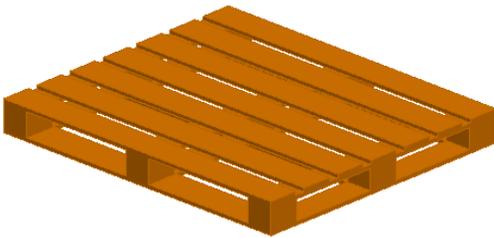
2. 3 x 2 x 3 Box Pattern

3. Angle Packing & Taping
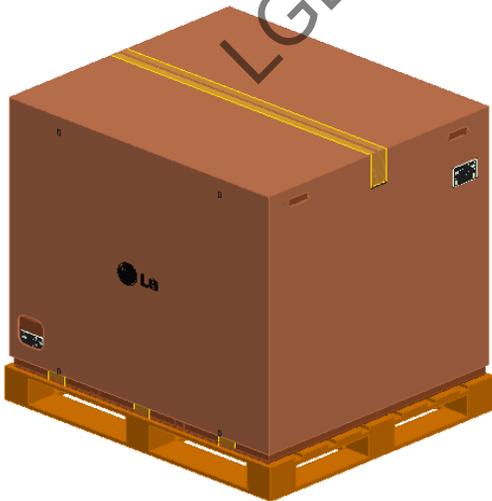
4. Banding
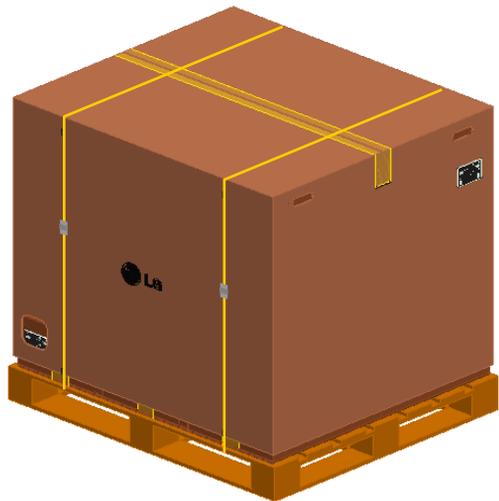
9. PRECAUTIONS

Please pay attention to the followings when you use this TFT LCD module.

9-1. MOUNTING PRECAUTIONS

(1) You must mount a module using holes arranged in four corners or four sides.
(2) You should consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
(3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
(4) You should adopt radiation structure to satisfy the temperature specification.
(5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
(6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
  Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics are detrimental to the polarizer.)
(7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
(8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
(9) Do not open the case because inside circuits do not have sufficient strength.
(10) When handling the LCD module, it needs to handle with care not to give mechanical stress to the PCB and Mounting Hole area."

9-2. OPERATING PRECAUTIONS

(1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage :
  V=± 200mV(Over and under shoot voltage)

(2) Response time depends on the temperature.(In lower temperature, it becomes longer.)
(3) Brightness depends on the temperature. (In lower temperature, it becomes lower.)
  And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer.
(4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
(5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
(6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.

9-3. ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

9-4. PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.

9-5. STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

(1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
(2) The polarizer surface should not come in contact with any other object.
 It is recommended that they be stored in the container in which they were shipped.

9-6. HANDLING PRECAUTIONS FOR PROTECTION FILM

(1) When the protection film is peeled off, static electricity is generated between the film and polarizer.
 This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
(2) The protection film is attached to the polarizer with a small amount of glue. If some stress is applied to rub the protection film against the polarizer during the time you peel off the film, the glue is apt to remain on the polarizer.
 Please carefully peel off the protection film without rubbing it against the polarizer.
(3) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the polarizer after the protection film is peeled off.
(4) You can remove the glue easily. When the glue remains on the polarizer surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

9-7. THE LGD QA RESPONSIBILITY WILL BE AVOIDED IN CASE OF BELOW

(1) When the customer attaches TSM(Touch Sensor Module) on LCM without Supplier's approval.
(2) When the customer attaches cover glass on LCM without Supplier's approval.
(3) When the LCMs were repaired by 3rd party without Supplier's approval.
(4) When the LCMs were treated like Disassemble and Rework by the Customer and/or Customer's representatives without supplier's approval.

FORTEC
ELEKTRONIK AG

Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

Headquarters

Germany

FORTEC
ELEKTRONIK AG

FORTEC Elektronik AG
Augsburger Str. 2b
82110 Germering

Phone:	+49 89 894450-0
E-Mail:	info@fortecag.de
Internet:	www.fortecag.de

Fortec Group Members

Austria

DISTEC
A FORTEC GROUP MEMBER

Distec GmbH Office Vienna
Nuschinggasse 12
1230 Wien

Phone:	+43 1 8673492-0
E-Mail:	info@distec.de
Internet:	www.distec.de

Germany

DISTEC
A FORTEC GROUP MEMBER

Distec GmbH
Augsburger Str. 2b
82110 Germering

Phone:	+49 89 894363-0
E-Mail:	info@distec.de
Internet:	www.distec.de

Switzerland

ALTRAC
A FORTEC GROUP MEMBER

ALTRAC AG
Bahnhofstraße 3
5436 Würenlos

Phone:	+41 44 7446111
E-Mail:	info@altrac.ch
Internet:	www.altrac.ch

United Kingdom

DISPLAY TECHNOLOGY
A FORTEC GROUP MEMBER

Display Technology Ltd.
Osprey House, 1 Osprey Court
Hichingbrooke Business Park
Huntingdon, Cambridgeshire, PE29 6FN

Phone:	+44 1480 411600
E-Mail:	info@displaytechnology.co.uk
Internet:	www. displaytechnology.co.uk

USA

APOLLO DISPLAY TECHNOLOGIES
A FORTEC GROUP MEMBER

Apollo Display Technologies, Corp.
87 Raynor Avenue,
Unit 1Ronkonkoma,
NY 11779

Phone:	+1 631 5804360
E-Mail:	info@apollodisplays.com
Internet:	www.apollodisplays.com